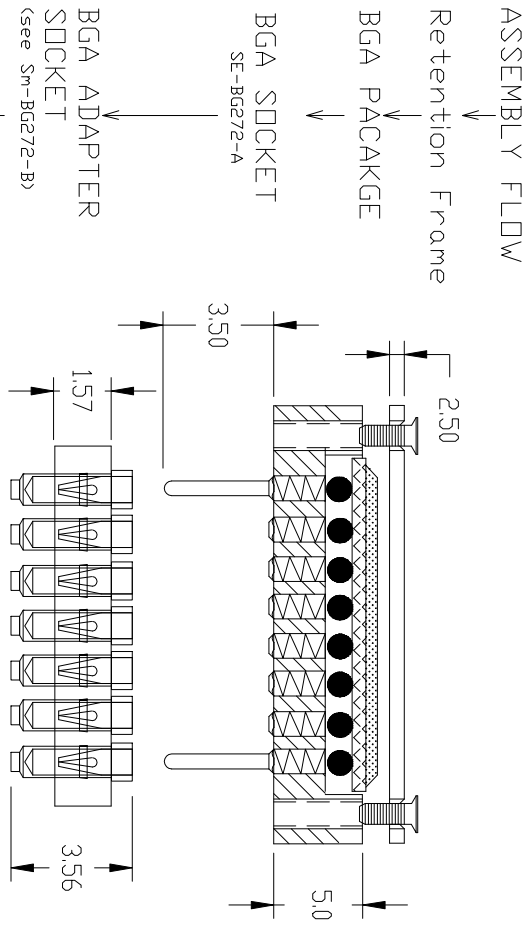


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ECN NO.	REV.	DESCRIPTION OF CHANGE	EFFECTIVE DATE	ORIGINATOR
060144	0	Initial	5/6/99	Ray Kiang
2000004	1	change B-tee number to BRW272-1270-20A011	1/6/2000	Ray Kiang



Solder past thickness need to be at least 0.20mm(0r0.008 inch) in order to have reliable solder joint

Please see detail drawing for part number

- Note: Dim: mm
- To remove BGA socket from adapter socket, Use removal tool from Mill-Max
 - Mill-Max phone: 516-922-6000

UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETERS DECIMAL		PROJECTION	
XX ±0.10	±1°		
XXX ±0.05			
XXXX ±0.03			
FINISH		APPROVALS	
SEE NOTES		DRAWN Ray Kiang	
DO NOT SCALE DRAWING		CHECKED	
		DATE 4/27/99	
		ENGR	
		RELEASED	
TITLE		TITLE	
272-27x27mm, 1.27mm E-TEC BGA SOCKET (272 BGA E-TEC Socket Assembly)		ACTEL CORP SUNNYVALE CA 94086	
SIZE B		VENDOR NAME e-tec	
VENDOR SUPPLY NUMBER		ACTEL DWG. NUMBER 1-07-09238	
SCALE: NONE		VENDOR DWG. NUMBER	
SHEET 2 OF 2		REV 1	

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